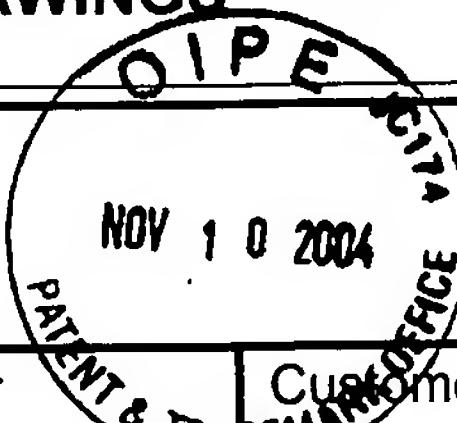


**TRANSMITTAL OF FORMAL DRAWINGS**Docket No.  
FIS920030031US1

In Re Application Of: Xinhui Wang et al.



Application No.	Filing Date	Examiner	Customer No.	Group Art Unit	Confirmation No.
10/707,120	11/21/2003	Dung V. Nguyen	32074	3723	1119

Invention: **ENDPOINT DETECTION IN CHEMICAL-MECHANICAL POLISHING OF PATTERNED WAFERS HAVING A LOW PATTERN DENSITY**

Address to:  
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Transmitted herewith are:

5 sheets of formal drawing(s) for this application.

- Each sheet of drawing indicates the identifying indicia suggested in 37 CFR Section 1.84(c).

Signature

Dated: 3 November 2004

Jay H. Anderson  
Reg. No. 38,371  
IBM Corporation, IPLAW  
2070 Route 52, Bldg. 300, Zip 482  
Hopewell Junction, NY 12533-6531

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on \_\_\_\_\_.

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